

SN54107, SN54LS107A, SN74107, SN74LS107A DUAL J-K FLIP-FLOPS WITH CLEAR

SDLS036 – DECEMBER 1983 – REVISED MARCH 1988

- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

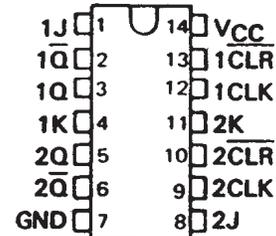
description

The '107 contain two independent J-K flip-flops with individual J-K, clock, and direct clear inputs. The '107 is a positive pulse-triggered flip-flop. The J-K input data is loaded into the master while the clock is high and transferred to the slave and the outputs on the high-to-low clock transition. For these devices the J and K inputs must be stable while the clock is high.

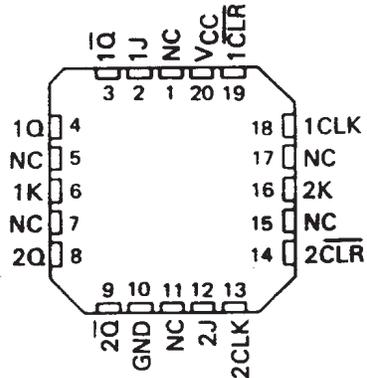
The 'LS107A contain two independent negative-edge-triggered flip-flops. The J and K inputs must be stable prior to the high-to-low clock transition for predictable operation. When the clear is low, it overrides the clock and data inputs forcing the Q output low and the \bar{Q} output high.

The SN54107 and the SN54LS107A are characterized for operation over the full military temperature range of -55°C to 125°C . The SN74107 and the SN74LS107A are characterized for operation from 0°C to 70°C .

SN54107, SN54LS107A . . . J PACKAGE
SN74107 . . . N PACKAGE
SN74LS107A . . . D OR N PACKAGE
(TOP VIEW)



SN54LS107A . . . FK PACKAGE
(TOP VIEW)



NC - No internal connection

'107
FUNCTION TABLE

INPUTS				OUTPUTS	
$\overline{\text{CLR}}$	CLK	J	K	Q	\bar{Q}
L	X	X	X	L	H
H	\downarrow	L	L	Q_0	\bar{Q}_0
H	\downarrow	H	L	H	L
H	\downarrow	L	H	L	H
H	\downarrow	H	H	TOGGLE	
H	H	X	X	Q_0	\bar{Q}_0

'LS107A
FUNCTION TABLE

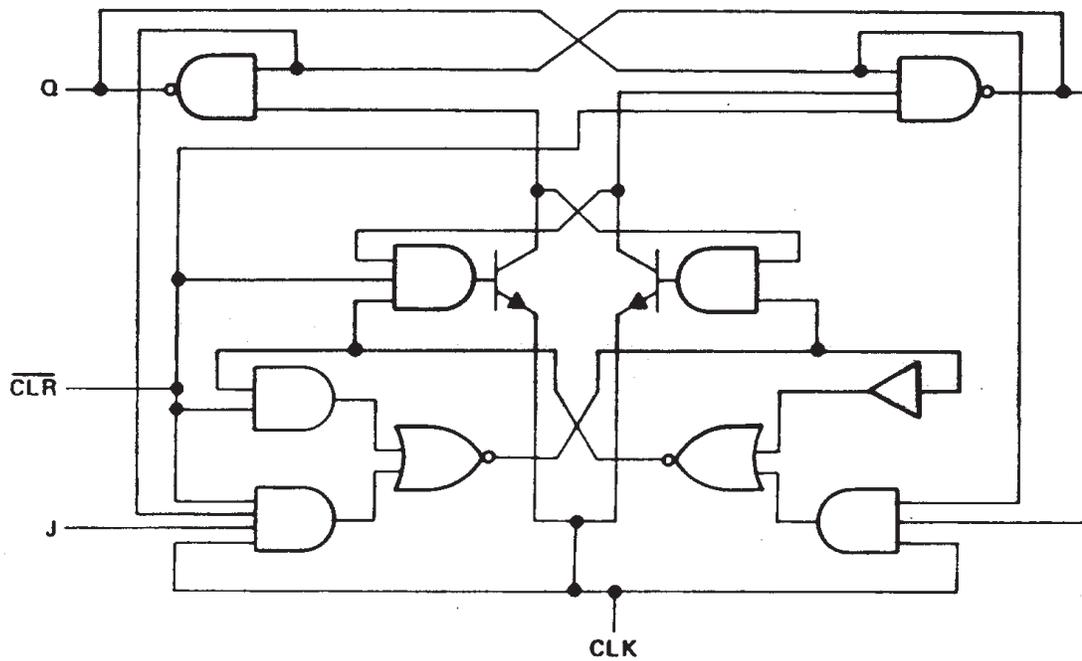
INPUTS				OUTPUTS	
$\overline{\text{CLR}}$	CLK	J	K	Q	\bar{Q}
L	X	X	X	L	H
H	\downarrow	L	L	Q_0	\bar{Q}_0
H	\downarrow	H	L	H	L
H	\downarrow	L	H	L	H
H	\downarrow	H	H	TOGGLE	
H	H	X	X	Q_0	\bar{Q}_0

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

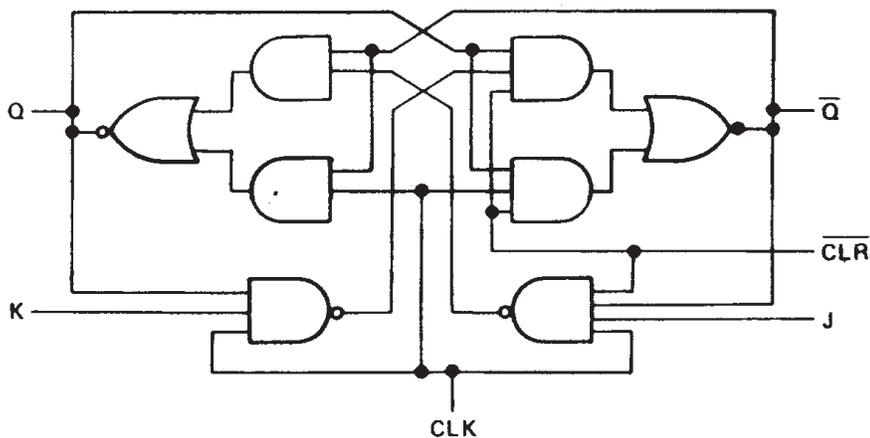


SN54107, SN54LS107A,
 SN74107, SN74LS107A
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logic diagrams (positive logic)



'LS107A

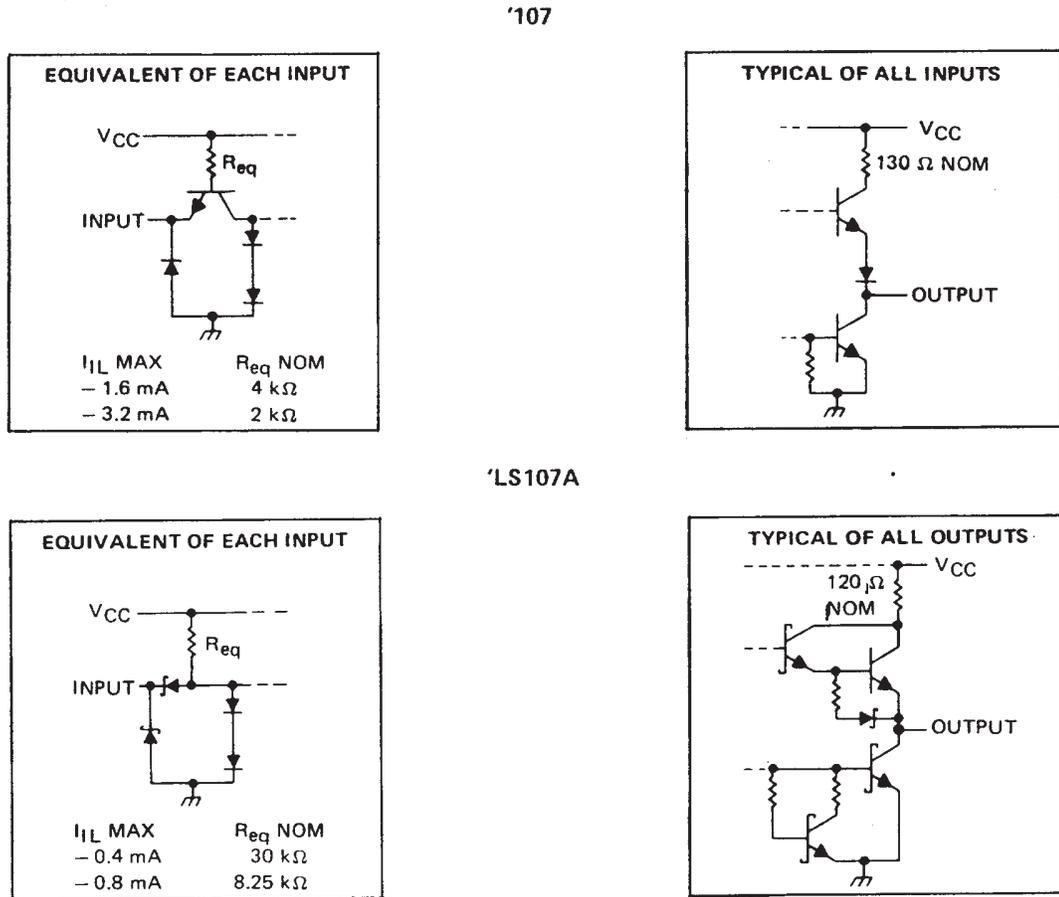


logic symbols †



†These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for D, J, and N packages.

schematic of inputs and outputs



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1)	7 V
Input voltage: '107	5.5 V
'LS107A	7 V
Operating free-air temperature range: SN54'	-55°C to 125°C
SN74'	0°C to 70°C
Storage temperature range	-65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

SN54107, SN74107 DUAL J-K FLIP-FLOPS WITH CLEAR

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recommended operating conditions

		SN54107			SN74107			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V_{IH}	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.8			0.8	V
I_{OH}	High-level output current			-0.4			-0.4	mA
I_{OL}	Low-level output current			16			16	mA
t_w	Pulse duration	CLK high		20	20		ns	
		CLK low		47	47			
		CLR low		25	25			
t_{su}	Input setup time before CLK†	0			0			ns
t_h	Input hold time-data after CLK†	0			0			ns
T_A	Operating free-air temperature	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS†	SN54107			SN74107			UNIT
		MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IK}	$V_{CC} = \text{MIN}$, $I_I = -12 \text{ mA}$			-1.5			-1.5	V
V_{OH}	$V_{CC} = \text{MIN}$, $V_{IH} = 2 \text{ V}$, $V_{IL} = 0.8 \text{ V}$, $I_{OH} = -0.4 \text{ mA}$	2.4	3.4		2.4	3.4		V
V_{OL}	$V_{CC} = \text{MIN}$, $V_{IH} = 2 \text{ V}$, $V_{IL} = 0.8 \text{ V}$, $I_{OL} = 16 \text{ mA}$		0.2	0.4		0.2	0.4	V
I_I	$V_{CC} = \text{MAX}$, $V_I = 5.5 \text{ V}$			1			1	mA
I_{IH}	J or K			40			40	μA
	All other			80			80	
I_{IL}	J or K			-1.6			-1.6	mA
	All other			-3.2			-3.2	
$I_{OS}§$	$V_{CC} = \text{MAX}$	-20		-57	-18		-57	mA
$I_{CC}¶$	$V_{CC} = \text{MAX}$, See Note 2		10	20		10	20	mA

†For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^\circ \text{C}$.

§Not more than one output should be shorted at a time.

¶Average per flip-flop.

NOTE 2: With all outputs open, I_{CC} is measured with the Q and \bar{Q} outputs high in turn. At the time of measurement, the clock input is grounded.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^\circ \text{C}$ (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f_{max}			$R_L = 400 \Omega$, $C_L = 15 \text{ pF}$	15	20		MHz
t_{PLH}	CLR	\bar{Q}			16	25	ns
t_{PHL}		Q			25	40	ns
t_{PLH}	CLK	Q or \bar{Q}			16	25	ns
t_{PHL}						25	40

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



SN54LS107A, SN74LS107A DUAL J-K FLIP-FLOPS WITH CLEAR

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recommended operating conditions

		SN54LS107A			SN74LS107A			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC}	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH}	High-level input voltage	2			2			V
V _{IL}	Low-level input voltage	0.7			0.8			V
I _{OH}	High-level output current	-0.4			-0.4			mA
I _{OL}	Low-level output current	4			8			mA
f _{clock}	Clock frequency	0	30		0	30		MHz
t _w	Pulse duration	CLK high		20		20		ns
		CLR low		25		25		
t _{su}	Setup time before CLK ↓	data high or low		20		20		ns
		CLR inactive		25		25		
t _h	Hold time-data after CLK ↓	0			0			ns
T _A	Operating free-air temperature	-55	125		0	70		°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS†	SN54LS107A		SN74LS107A		UNIT
		MIN	TYP ‡	MAX	MIN	
V _{IK}	V _{CC} = MIN, I _I = -18 mA	-1.5		-1.5		V
V _{OH}	V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = MAX, I _{OH} = -0.4 mA	2.5	3.4	2.7	3.4	V
V _{OL}	V _{CC} = MIN, V _{IL} = MAX, V _{IH} = 2 V, I _{OL} = 4 mA	0.25	0.4	0.25	0.4	V
	V _{CC} = MIN, V _{IL} = MAX, V _{IH} = 2 V, I _{OL} = 8 mA			0.35	0.5	
I _I	J or K	0.1		0.1		mA
	CLR	0.3		0.3		
	CLK	0.4		0.4		
I _{IH}	J or K	20		20		μA
	CLR	60		60		
	CLK	80		80		
I _{IL}	J or K	-0.4		-0.4		mA
	CLR or CLK	-0.8		-0.8		
I _{OS} §	V _{CC} = MAX, See Note 4	-20	-100	-20	-100	mA
I _{CC} (Total)	V _{CC} = MAX, See Note 2	4	6	4	6	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.

§ Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

NOTE 2: With all outputs open, I_{CC} is measured with the Q and \bar{Q} , outputs high in turn. At the time of measurement, the clock input is grounded.

NOTE 4: For certain devices where state commutation can be caused by shorting an output to ground, an equivalent test may be performed with V_O = 2.25 V and 2.125 V for the 54 family and the 74 family, respectively, with the minimum and maximum limits reduced to one half of their stated values.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f _{max}			R _L = 2 kΩ, C _L = 15 pF	30	45		MHz
t _{PLH}	\bar{CLR} or CLK	Q or \bar{Q}		15	20		ns
t _{PHL}				15	20		ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



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